

MATERIAL DECLARATION SHEET



Material Number	CG0402MLC Series			
Product Line	ESD Suppressor			
Compliance Date	2014.Jun.11			
RoHS Compliant	Yes	MSL	1	

No.	Construction Element(subpart)	Homogeneous Material	Material weight [g]	Homogeneous Material\ Substances	CASRN if applicable	Materials Mass %	Material Mass % of total unit wt.	Subpart mass of total wt. (%)
1	Ceramic Substrate	Ceramic	0.0004280587	Aluminum oxide	1344-28-1	96	67.36	70.17
				Silicon dioxide	14808-60-7	3	2.11	
				Magnesium oxide	1309-48-4	1	0.70	
2	Inner Conductor	Ti-W	0.0000023329	Titanium	7440-32-6	90	0.34	0.38
				Tungsten	7440-33-7	10	0.04	
		Cu	0.0000020484	Copper	7440-50-8	100	0.34	0.34
3	ESD Suppressor Element	Cu	0.0000247515	Copper	7440-50-8	100	4.06	4.06
4	Over Coat	Epoxy	0.0000410000	Epoxy	25068-38-6	100	6.72	6.72
5	End Terminal	Ni-Cr	0.0000003983	Nickel	7440-02-0	80	0.06	0.07
				Chromium	7440-47-3	20	0.01	
6	Ni Plating	Ni	0.0000588915	Nickel	7440-02-0	100	9.65	9.65
7	Sn Plating	Sn	0.0000525187	Tin	7440-31-5	100	8.61	8.61
			Total weight			0.00061		

This Document was updated on: **2014.06.11**

Important remarks:

1. It is the responsibility of the user to verify they are accessing the latest version.